

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4656240

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
STEVEN BARCELO	10/20/2017
ANITA ROGACS	10/23/2017
VIKTOR SHKOLNIKOV	10/24/2017
MILO OVERBAY	10/24/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Hewlett-Packard Development Company, L.P.
<b>Street Address:</b>	11445 Compaq Center Drive West
<b>City:</b>	Houston
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	77070
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15792732
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(970)778-4063
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(541)715-8443
<b>Email:</b>	ipa.mail@hp.com
<b>Correspondent Name:</b>	HP INC.
<b>Address Line 1:</b>	3390 E. HARMONY ROAD MS 35
<b>Address Line 2:</b>	INTELLECTUAL PROPERTY
<b>Address Line 4:</b>	FORT COLLINS, COLORADO 80528
<b>ATTORNEY DOCKET NUMBER:</b>	84671770
<b>NAME OF SUBMITTER:</b>	TODD A. RATHE
<b>SIGNATURE:</b>	/Todd A. Rathe/
<b>DATE SIGNED:</b>	10/24/2017
<b>Total Attachments: 8</b>	
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HP Inc.  
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Mail Stop 35  
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 84671770

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each), for good and valuable consideration, the receipt of which is hereby acknowledged, and in furtherance of my/our obligations to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), and to its subsidiaries and affiliates, agree to assign and transfer and hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Patent entitled:

MICROFLUIDIC CHIP WITH ANCHORED NANO PARTICLE ASSEMBLY

Filing Date: \_\_\_\_\_ Application No.: \_\_\_\_\_

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Patent, and any and all other Patent of any countries thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Patent.

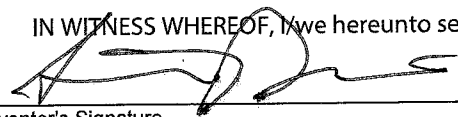
I/we additionally authorize HPDC to file applications in my/our name for Patent in any country, to be held and enjoyed by HPDC, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Patent, to HPDC, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HPDC, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HPDC, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HPDC;

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IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

  
Inventor's Signature

10/20/17  
Date

Steven

Barcelo

First/Middle Name

Last Name

\_\_\_\_\_  
Inventor's Signature

\_\_\_\_\_  
Date

Anita

Rogacs

First/Middle Name

Last Name

HP Inc.  
3390 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

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**ASSIGNMENT OF PATENT APPLICATION (cont.)**

\_\_\_\_\_  
Inventor's Signature Date

Viktor Shkolnikov  
\_\_\_\_\_  
First/Middle Name Last Name

\_\_\_\_\_  
Inventor's Signature Date

Milo Overbay  
\_\_\_\_\_  
First/Middle Name Last Name

\_\_\_\_\_  
Inventor's Signature Date

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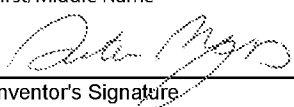
\_\_\_\_\_  
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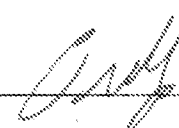
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Inventor's Signature  \_\_\_\_\_ Date 10/24/17

Milo Overbay  
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